



Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	I_D
-30V	14m Ω @-10V	-30A
	22m Ω @-4.5V	

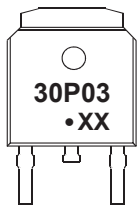
Feature

- TrenchFET Power MOSFET
- Excellent $R_{DS(on)}$
- Low Gate Charge

ApplicationS

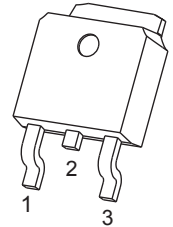
- Load Switch for Portable Devices
- Battery Switch

MARKING:



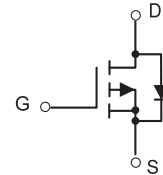
30P03 = Device code
 XX = Date Code
 Solid dot = Green molding compound device,
 If none, the normal device.

TO-252



1. GATE
2. DRAIN
3. SOURCE

Schematic diagram



ABSOLUTE MAXIMUM RATINGS ($T_a=25^{\circ}C$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	-30	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current	I_D	-30	A
Pulsed Drain Current	I_{DM}	-120	A
Power Dissipation	P_D	1.25	W
Thermal Resistance from Junction to Ambient($t \leq 10s$)	$R_{\theta JA}$	100	$^{\circ}C/W$
Junction Temperature	T_J	150	$^{\circ}C$
Storage Temperature	T_{STG}	-55~ +150	$^{\circ}C$

MOSFET ELECTRICAL CHARACTERISTICS (T_a=25°C unless otherwise noted)

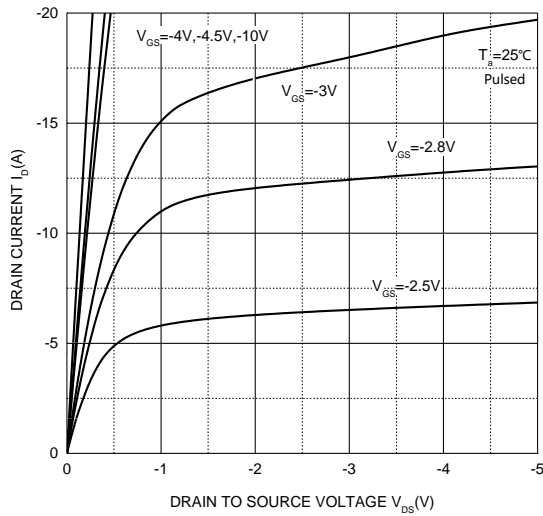
Parameter	Symbol	Test Condition	Min	Type	Max	Unit
Static Characteristics						
Drain-source breakdown voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = -250μA	-30			V
Zero gate voltage drain current	I _{DSS}	V _{DS} = -30V, V _{GS} = 0V			-1	μA
Gate-body leakage current	I _{GSS}	V _{GS} = ±20V, V _{DS} = 0V			±0.1	μA
On characteristics⁽¹⁾						
Gate threshold voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = -250μA	-1.0	-1.5	-2.5	V
Drain-source on-resistance	R _{DS(on)}	V _{GS} = -10V, I _D = -20A		14	18	mΩ
		V _{GS} = -4.5V, I _D = -10A		22	30	
Forward transconductance	g _{FS}	V _{DS} = -10V, I _D = -20A		14		S
Dynamic characteristics⁽²⁾						
Input capacitance	C _{ISS}	V _{DS} = -15V, V _{GS} = 0V, f = 1MHz		1700		pF
Output capacitance	C _{OSS}			210		
Reverse transfer capacitance	C _{RSS}			190		
Switching characteristics⁽²⁾						
Total gate charge	Q _g	V _{DS} = -15V, V _{GS} = -10V, I _D = -15A			30	nC
Gate-source charge	Q _{gs}				8.5	
Gate-drain charge	Q _{gd}				14	
Turn-on delay time	t _{d(on)}	V _{DD} = -15V, V _{GS} = -10V, R _G = 1Ω , R _L = 15Ω			18	ns
Turn-on rise time	t _r				18	
Turn-off delay time	t _{d(off)}				84	
Turn-off fall time	t _f				30	
Drain-Source Diode Characteristics						
Drain-source diode forward voltage ⁽¹⁾	V _{SD}	V _{GS} = 0V, I _S = -10A			-1.2	V
Continuous drain-source diode forward current	I _S				-30	A
Pulsed drain-source diode forward current	I _{SM}				-120	

Notes:

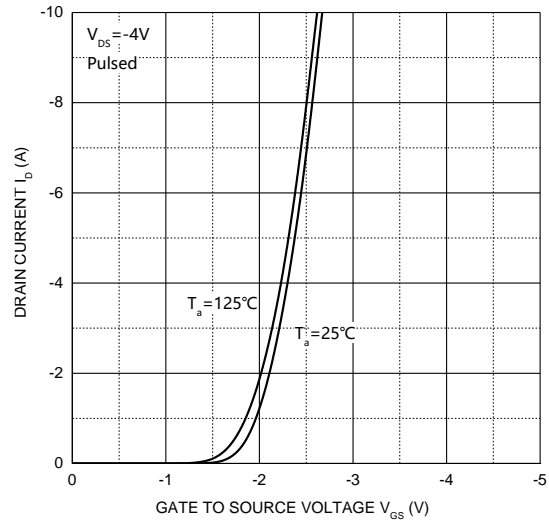
1. Pulse test; pulse width ≤ 300μs, duty cycle ≤ 2%.
2. Guaranteed by design, not subject to production testing.

Typical Electrical and Thermal Characteristics

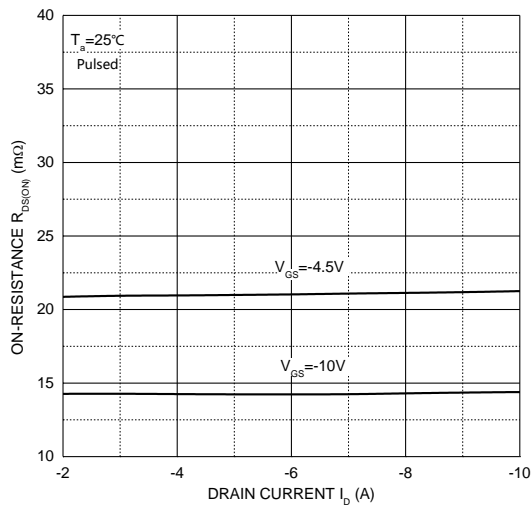
Output Characteristics



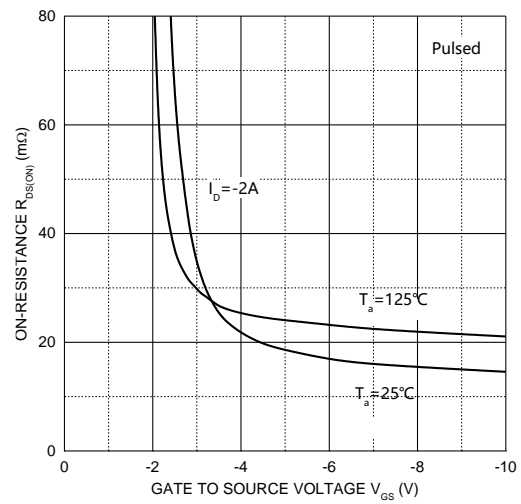
Transfer Characteristics



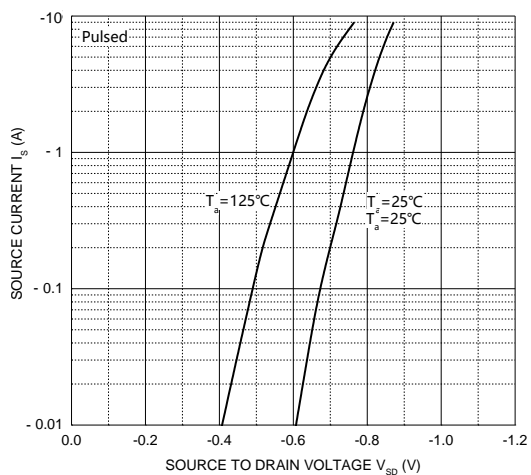
$R_{DS(ON)} - I_D$



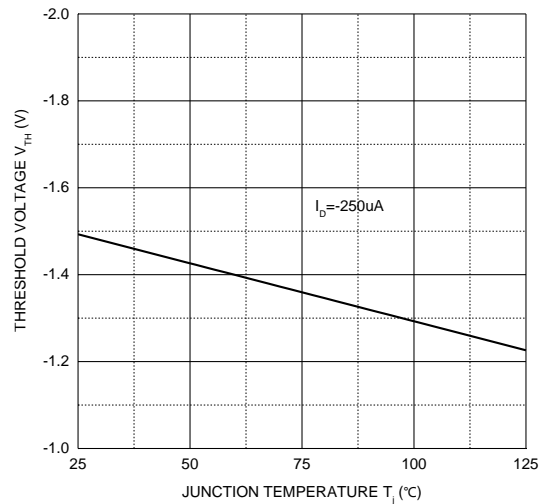
$R_{DS(ON)} - V_{GS}$



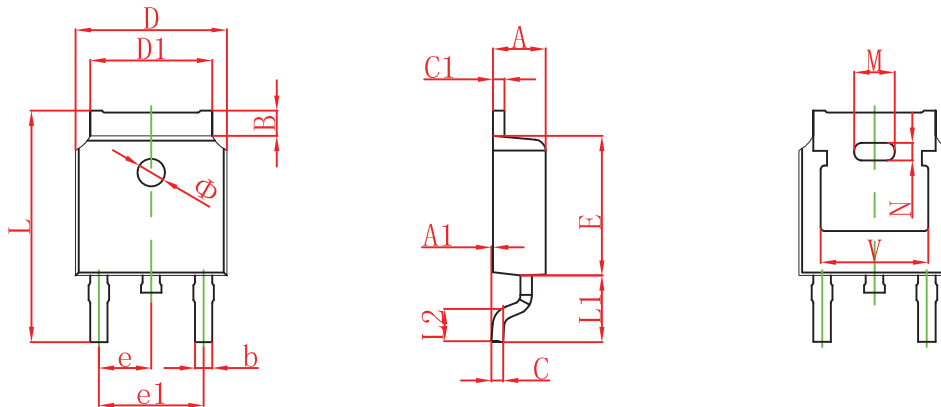
$I_S - V_{SD}$



Threshold Voltage



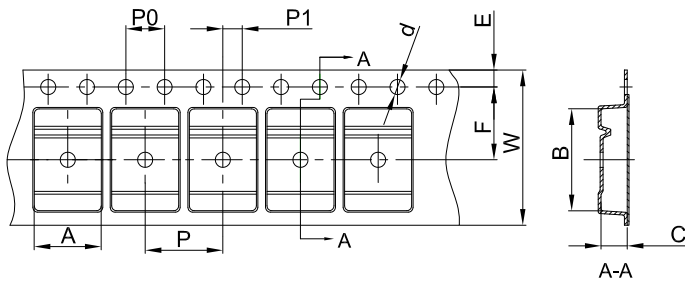
TO-252 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	2.200	2.380	0.087	0.094
A1	0.000	0.100	0.000	0.004
B	0.800	1.400	0.031	0.055
b	0.710	0.810	0.028	0.032
c	0.460	0.560	0.018	0.022
c1	0.460	0.560	0.018	0.022
D	6.500	6.700	0.256	0.264
D1	5.130	5.460	0.202	0.215
E	6.000	6.200	0.236	0.244
e	2.286 TYP.		0.090 TYP.	
e1	4.327	4.727	0.170	0.186
M	1.778REF.		0.070REF.	
N	0.762REF.		0.018REF.	
L	9.800	10.400	0.386	0.409
L1	2.9REF.		0.114REF.	
L2	1.400	1.700	0.055	0.067
V	4.830 REF.		0.190 REF.	
Φ	1.100	1.300	0.043	0.051

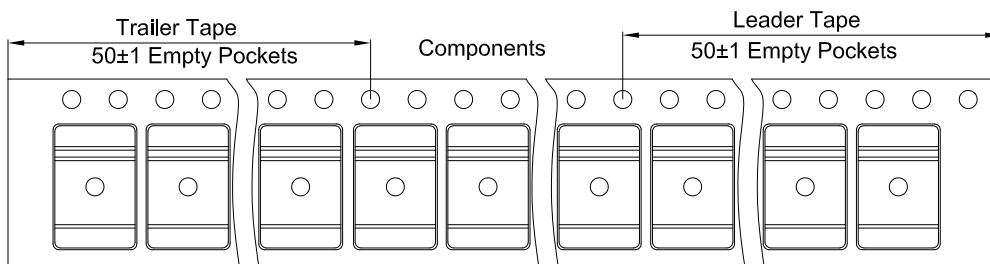
TO-252 Package Information

TO-252 Embossed Carrier Tape

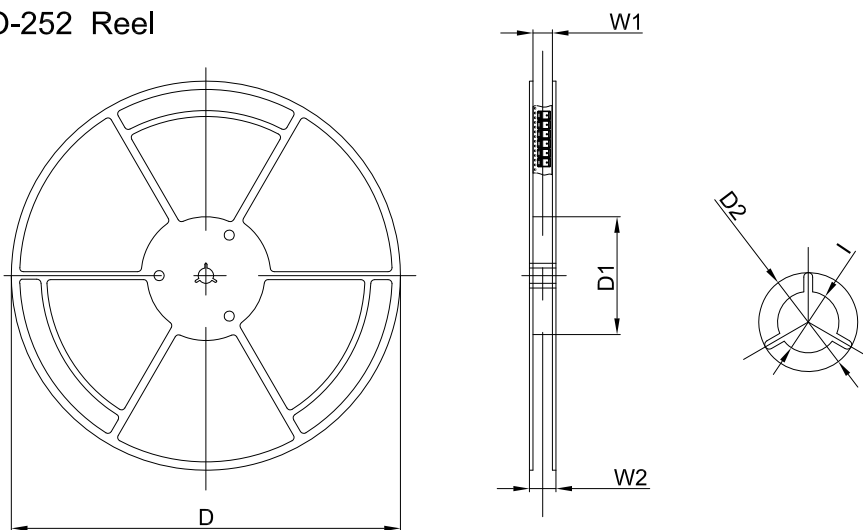


Dimensions are in millimeter											
Pkg type	A	B	C	d	E	F	P0	P	P1	W	
TO-252	6.90	10.50	2.70	Ø1.55	1.75	7.50	4.00	8.00	2.00	16.00	

TO-252 Tape Leader and Trailer



TO-252 Reel



Dimensions are in millimeter						
Reel Option	D	D1	D2	W1	W2	I
13" Dia	330.00	100.00	Ø21.00	16.40	21.00	Ø13.00

REEL	Reel Size	Box	Box Size(mm)	Carton	Carton Size(mm)	G.W.(kg)
2,500 pcs	13inch	2,500 pcs	340×336×29	25,000 pcs	353×346×365	

单击下面可查看定价，库存，交付和生命周期等信息

[>>GP\(格瑞宝\)](#)